

NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V _{CC}	50V
I _{C(MAX.)}	100mA
R ₁	1.0kΩ
R_2	10kΩ

Features

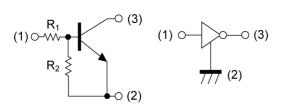
- 1) Built-In Biasing Resistors, $R_1 = 1k\Omega$, $R_2 = 10k\Omega$
- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA113Z series

Application

INVERTER, INTERFACE, DRIVER

Inner circuit

DTC113ZM/ DTC113ZEB/ DTC113ZUB

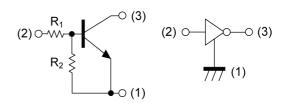


- (1) IN (BASE)
- (2) GND (EMITTER)
- (3) OUT (COLLECTOR)

Outline

• Outilite	
SOT-723	SOT-416FL
DTC113ZM (VMT3)	DTC113ZEB (EMT3F)
SOT-416	SOT-323FL
DTC113ZE (EMT3)	DTC113ZUB (UMT3F)
SOT-323	SOT-346
DTC113ZUA (UMT3)	DTC113ZKA (SMT3)

DTC113ZE/ DTC113ZUA/ DTC113ZKA



- (1) GND (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC113ZM	SOT-723	1212	T2L	180	8	8000	E21
DTC113ZEB	SOT-416FL	1616	TL	180	8	3000	E21
DTC113ZE	SOT-416	1616	TL	180	8	3000	E21
DTC113ZUB	SOT-323FL	2021	TL	180	8	3000	121
DTC113ZUA	SOT-323	2021	T106	180	8	3000	121
DTC113ZKA	SOT-346	2928	T146	180	8	3000	E21

● **Absolute maximum ratings** (T_a = 25°C)

P	Parameter	Symbol	Values	Unit
Supply voltage	V _{CC}	50	V	
Input voltage	Input voltage			V
Output current	Output current			mA
Collector current			100	mA
	DTC113ZM		150	
	DTC113ZEB		150	
Davis a dia sia stis a	DTC113ZE	P _D *2	150	\0/
Power dissipation	DTC113ZUB	P _D ²	200	mW
	DTC113ZUA		200	
	DTC113ZKA		200	
Junction temperature	T _j	150	°C	
Range of storage tempera	ature	T _{stg}	-55 to +150	°C

● Electrical characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
lanut voltore	$V_{l(off)}$	$V_{CC} = 5V, I_{O} = 100 \mu A$	-	-	0.3	V
Input voltage	V _{I(on)}	V _O = 0.3V, I _O = 20mA	3.0	-	-	V
Output voltage	V _{O(on)}	I _O = 10mA, I _I = 0.5mA	1	100	300	mV
Input current	l _l	V _I = 5V	1	-	7.2	mA
Output current	I _{O(off)}	$V_{CC} = 50V, V_{I} = 0V$	1	-	500	nA
DC current gain	G _I	$V_{O} = 5V, I_{O} = 5mA$	33	-	-	-
Input resistance	R ₁	-	0.7	1.0	1.3	kΩ
Resistance ratio	R ₂ /R ₁	-	8	10	12	-
Transition frequency	f _T *1	$V_{CE} = 10V, I_{E} = -5mA,$ f = 100MHz	-	250	-	MHz

^{*1} Characteristics of built-in transistor

^{*2} Each terminal mounted on a reference land.

● Electrical characteristic curves (T_a =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

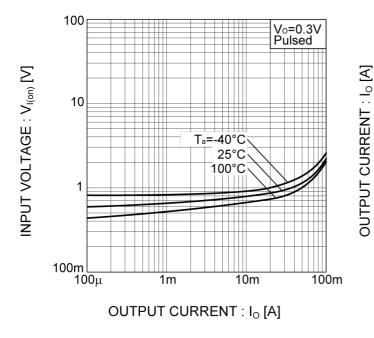


Fig.2 Output current vs. input voltage (OFF characteristics)

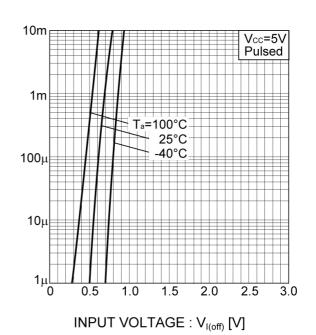


Fig.3 Output current vs. output voltage

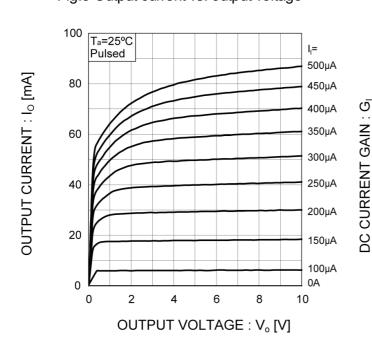
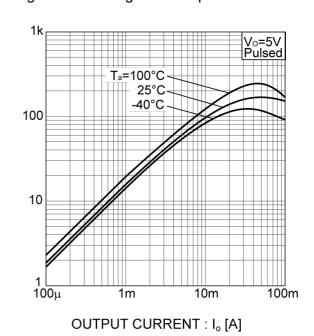
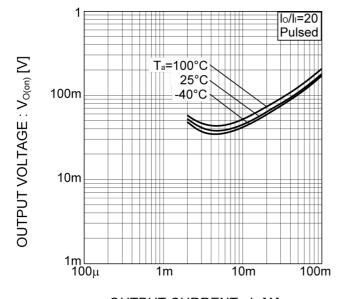


Fig.4 DC current gain vs. output current

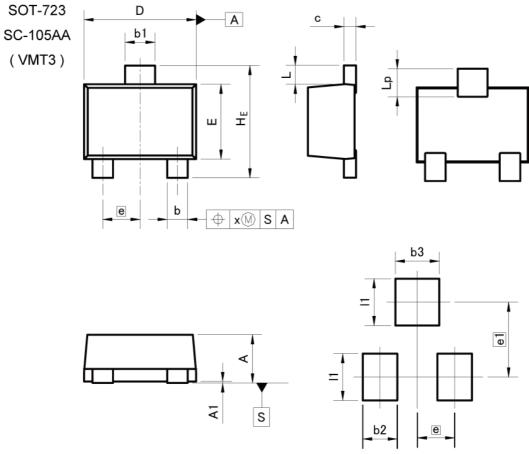


●Electrical characteristic curves (T_a =25°C)

Fig.5 Output voltage vs. output current



OUTPUT CURRENT : Io [A]



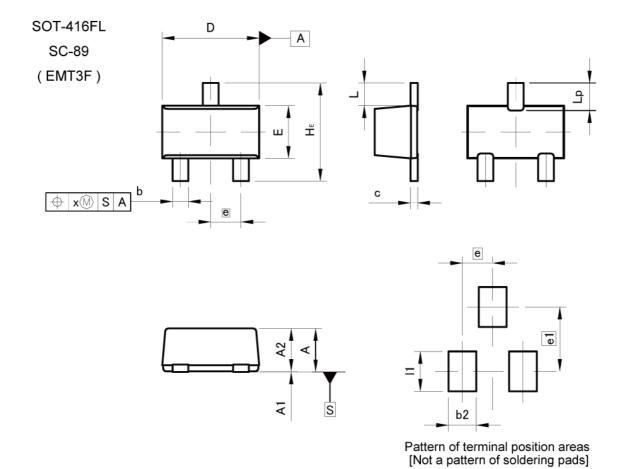
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.	40	0.0	02
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х	-	0.10	_	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	_	0.015
b3	_	0.47	7-	0.019
e1	0.80		0.0	31
11	=	0.50		0.020

Dimension in mm/inches



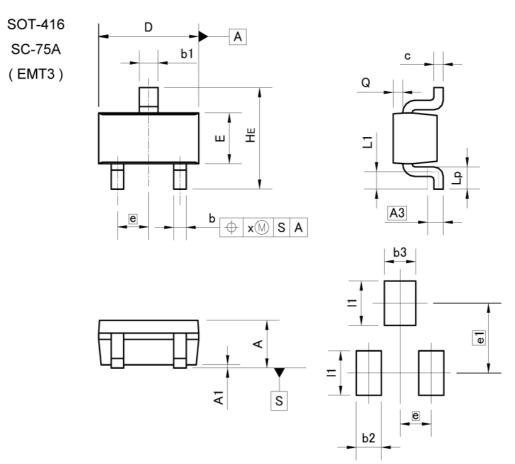


8.797.777.877	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
	INITIA	WAA	INITIA	IVIAA
Α	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.	50	0.0	20
HE	1.50	1.70	0.059	0.067
L	0.	37	0.0	15
Lp	0.35	0.55	0.014	0.022
×	-	0.10	-	0.004

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	_	0.46	_	0.018	
e1	_	1.05	-	0.041	
- 11	-	0.65	-	0.026	

Dimension in mm/inches





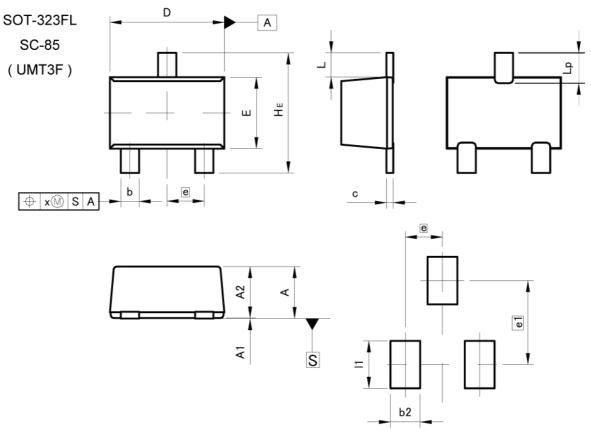
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
Е	0.70	0.90	0.028	0.035
е	0.	50	0.0	20
HE	1.40	1.80	0.055	0.071
L1	0.10	-	0.004	l -
Lp	0.15		0.006	7. -
Q	0.05	0.25	0.002	0.010
х	-	0.10	, - ,	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	1	0.40	-	0.016
b3	I	0.50	-	0.020
e1	1.10		0.0	143
l1	i –	0.70	-	0.028

Dimension in mm/inches





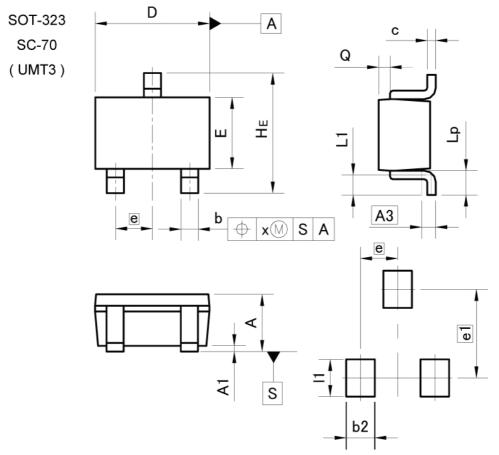
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.0	26
HE	2.00	2.20	0.079	0.087
L	0.4	25	0.0	17
Lp	0.43	0.63	0.017	0.025
х	_	0.10	-	0.004

DIM	MILIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
b2	_	0.52	-	0.020	
e1	1.47		0.0	058	
I1	ı	0.83	ı	0.033	

Dimension in mm/inches





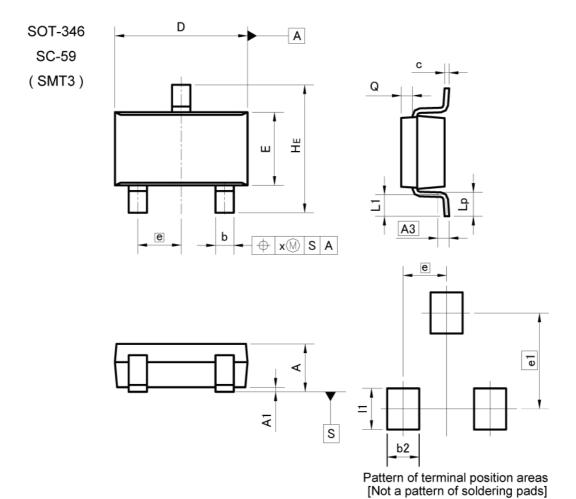
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0.000	0.004	
A3	A3 0.25		0.0	0.010	
b	0.25	0.40	0.010	0.016	
С	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.65		0.026		
HE	2.00	2.20	0.079	0.087	
L1	0.10	0.40	0.004	0.016	
Lp	0.25	0.55	0.010	0.022	
Q	0.10	0.30	0.004	0.012	
х	_	0.10	_	0.004	

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	_	0.50	_	0.020	
e1	1.55		0.0	061	
11	-	0.65	-	0.026	

Dimension in mm/inches





DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	1.00	1.30	0.039	0.051	
A1	0.00	0.10	0.000	0.004	
A3	0.25		0.0		
b	0.35	0.50	0.014	0.020	
С	0.09	0.25	0.004	0.010	
D	2.80	3.00	0.110	0.118	
E	1.50	1.80	0.059	0.071	
е	0.95		0.037		
HE	2.60	3.00	0.102	0.118	
L1	0.30	0.60	0.012	0.024	
Lp	0.40	0.70	0.016	0.028	
Q	0.20	0.30	0.008	0.012	
х	-,	0.10	-	0.004	
У	- ,,	0.10	c=-	0.004	

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2		0.60	-	0.024
e1	2.10		0.083	
- 11	-,:	0.90	-	0.035

Dimension in mm/inches



Notice

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Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CL A CC TT
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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NSBC113EF3T5G NSBC124XF3T5G SMUN5330DW1T1G SSVMUN5312DW1T2G RN1303(TE85L,F) RN1306(TE85L,F)

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NSBC123EF3T5G NSBC143ZPDP6T5G NSBC144TF3T5G NSVMUN5113DW1T3G SMUN2214T1G FMA7AT148 MUN2135T1G

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SMUN5113T1G SMUN2111T1G DTC124ECA-TP DTC123TM3T5G DTA114ECA-TP DTC113EM3T5G NSVMUN5135DW1T1G

NSVMUN2237T1G NSVDTC143ZM3T5G